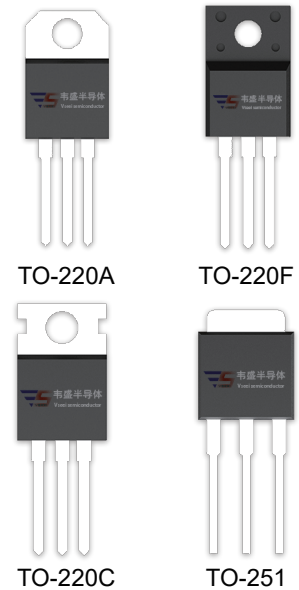


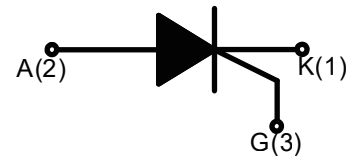
DESCRIPTION:

With high ability to withstand the shock loading of large current, TYN612 series of silicon controlled rectifiers provide high dv/dt rate with strong resistance to electromagnetic interference. They are especially recommended for use on solid state relay, motorcycle, power charger, T-tools etc.



MAIN FEATURES

Symbol	Value	Symbol
V_{DRM}/V_{RRM}	650/800	V
$I_{T(RMS)}$	12	A
I_{GT}	≤ 15	mA



ABSOLUTE MAXIMUM RATINGS

Parameter		Symbol	Value	Unit
Storage junction temperature range		T_{stg}	-40 - 150	$^{\circ}\text{C}$
Operating junction temperature range		T_j	-40 - 150	$^{\circ}\text{C}$
Repetitive peak off-state voltage ($T_j=25^{\circ}\text{C}$)		V_{DRM}	650/800	V
Repetitive peak reverse voltage ($T_j=25^{\circ}\text{C}$)		V_{RRM}	650/800	V
RMS on-state current	TO-251/ TO-220C/ TO-220A (Non-Ins) ($T_C=130^{\circ}\text{C}$)	$I_{T(RMS)}$	12	A
	TO-220A (Ins)/ TO-220F (Ins) ($T_C=125^{\circ}\text{C}$)			
Non repetitive surge peak on-state current ($F=50\text{Hz}$ $t_p=10\text{ms}$)		I_{TSM}	120	A

Non repetitive surge peak on-state current (F=60Hz tp=8.3ms)	I_{TSM}	132	A
I^2t value for fusing (tp=10ms)	I^2t	72	A ² s
Repetitive rate of rise of on-state current ($I_G=2 \times I_{GT}$)	dI_T/dt	50	A/ μ s
Peak gate current	I_{GM}	2	A
Peak gate power	P_{GM}	5	W
Average gate power dissipation	$P_{G(AV)}$	0.5	W

ELECTRICAL CHARACTERISTICS ($T_j=25^\circ\text{C}$ unless otherwise specified)

Symbol	Test Condition	Value			Unit
		MIN.	TYP.	MAX.	
I_{GT}	$V_D=12V$ $R_L=33\Omega$	-	4	15	mA
V_{GT}		-	0.75	1.5	V
V_{GD}	$V_D=V_{DRM}$ $T_j=150^\circ\text{C}$ $R_L=3.3K\Omega$	0.2	-	-	V
I_L	$I_G=1.2I_{GT}$	-	12	40	mA
I_H	$I_T=500\text{mA}$	-	12	30	mA
dV/dt	$V_D=540V$ Gate Open $T_j=150^\circ\text{C}$	50	-	-	V/ μ s
dV/dt	$V_D=436V$ Gate Open $T_j=150^\circ\text{C}$	80	-	-	V/ μ s
t_{on}	$I_{GT}=20\text{mA}$ $I_A=100\text{mA}$ $I_R=10\text{mA}$ $T_j=25^\circ\text{C}$	-	2	-	μ s
t_{off}		-	30	-	μ s
R_d	Dynamic resistance $T_j=125^\circ\text{C}$	-	-	35	m Ω

STATIC CHARACTERISTICS

Symbol	Parameter		Value(MAX)	Unit
V_{TM}	$I_{TM}=23A$ tp=380 μ s	$T_j=25^\circ\text{C}$	1.6	V
I_{DRM}	$V_D=V_{DRM}$ $V_R=V_{RRM}$	$T_j=25^\circ\text{C}$	10	μ A
I_{RRM}		$T_j=150^\circ\text{C}$	1	mA

THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	Junction to case	TO-251/ TO-220C/ TO-220A (Non-Ins)	1.3	°C/W
		TO-220A (Ins)	1.6	
		TO-220F (Ins)	1.7	

FIG.1: Maximum power dissipation versus RMS on-state current

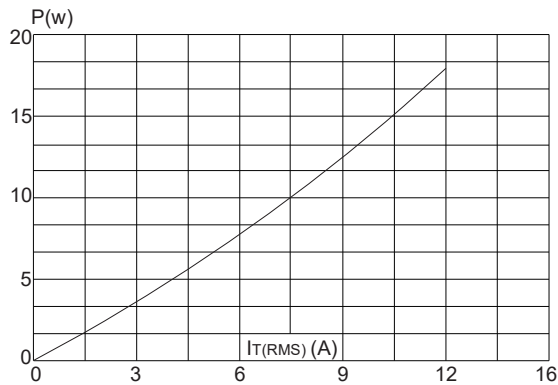


FIG.3: Surge peak on-state current versus number of cycles

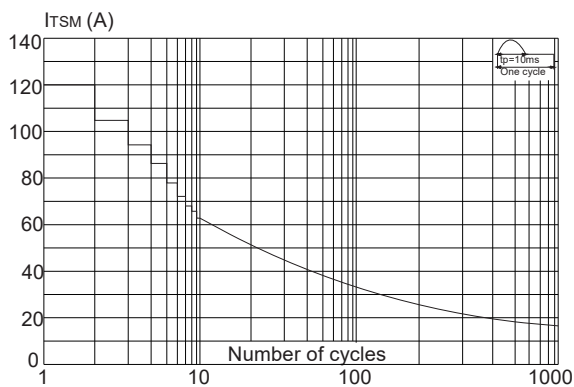


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 10\text{ms}$, and corresponding value of I^2t ($di/dt < 50\text{A}/\mu\text{s}$)

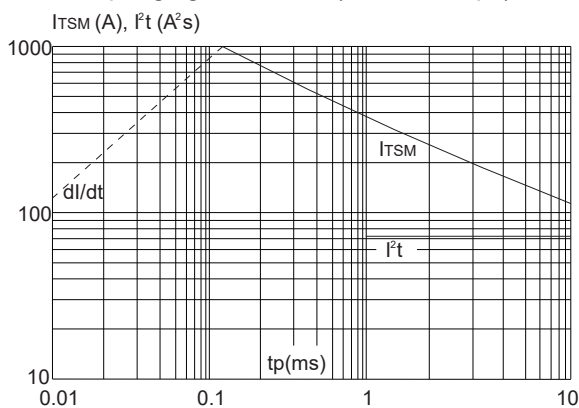


FIG.2: RMS on-state current versus case temperature

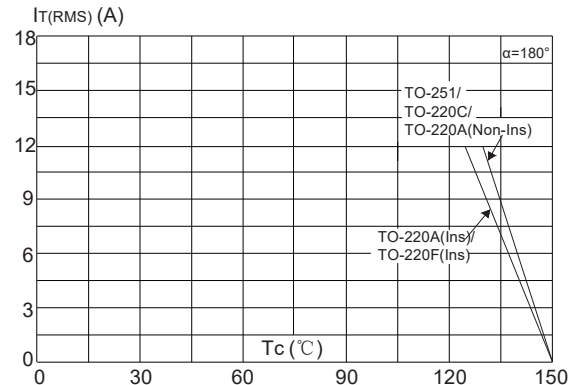


FIG.4: On-state characteristics (maximum values)

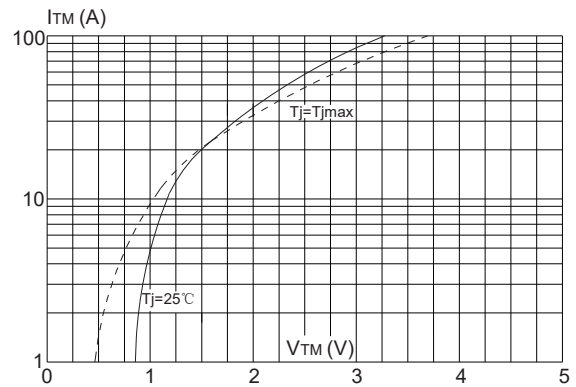


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature

